ASSOCIATION CONNECTING ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® international and Pa	IPC. Bannockl	burn, Illinois, A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarati the declaration e	on of the su	bstances v s all lower	vithin the manufactu level materials for v	rer listed	tem. Note: nanufacture	if the item is an as er has engineering	sembly with low responsibility.	
IPC Web Site for Information on IPC-1752 Standard Form			Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and					ials and M	lfg Informa	tion			
Supplier Information														
Company name* Company uni			ique ID U			Unique ID Authority				Respon	Response Date*			
nsemi										2024-09-24				
Contact Name	ttact Name Title - Contact					Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards Product Enviro Com			ro Compliance	Compliance		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representat			entative		Phone - Representative*			Email - Representative*						
Product-Env-Stewards Product			oduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
	SZMMS	SZMMSZ5254ET1G ZENER REGULAT		ATOR DIODE		2024-09-24 CN1		N1		11.67	mg	Each		
Ianufacturing Proccess Informa	ntion						-	·						
Terminal Plating / Grid Array M	aterial	al Terminal Base Alloy J-		J-STD-020 MSL	Rating	Peak Process Body Temperat		emperature	ure Max Time at Peak Temper		ture Num	ber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	seco	nds 3				
omments														
vel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds											
or more information regarding materia	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.88	mg	Supplier	Silicon (Si)	7440-21-3		0.88	mg
Lead Frame	3.19	mg	В	Nickel (Ni)	7440-02-0		1.158	mg
			Supplier	Iron (Fe)	7439-89-6		1.6014	mg
			Supplier	Copper (Cu)	7440-50-8		0.4306	mg
Mold Compound-Black	6.51	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.651	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0325	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.9439	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.2315	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.651	mg
Plating	0.8	mg	Supplier	Tin (Sn)	7440-31-5		0.8	mg
Wire Bond - Au	0.29	mg	Supplier	Gold (Au)	7440-57-5		0.29	mg